

JEAN-151-SAC305-T4

Rev: 27.10

Date 2023.07.06
 Language English
 SDS 950631



SUMMARY

Pb-free - Halide-free - Premium latest technology No-Clean, Fine Pitch solder paste

PASTE	JEAN-151-SAC305-T4
PROCESS	
No-Clean process	9
Post-solder cleaning	9

INDUSTRY APPLICATION	
Standard electronics	8
Industrial electronics	9
Hi-Rel electronics (automotive)	9

PROCESS CAPABILITY	
Squeegee	9
ProFlow	TBD
Pb-free Profile Air, short	9
Pb-free Profile Air, long	8
Pb-free process N2	9
Vapor phase process	8
Shiny joint appearance	8
Cosmetic cleanliness	8
ICCT compatible	N/A
Conformal coating	N/A

Legend	
<i>Especially made for this purpose</i>	9 - 10
<i>Generally qualified for this purpose</i>	7 - 8
<i>Generally usable, but not the best choice</i>	5 - 6
<i>Generally not usable for this purpose</i>	3 - 4
<i>Wrong choice</i>	1 - 2

Check material compatibility with every process change!

Industrial chemical product.

Read MSDS before use.

<25 °C

Disclaimer:

This information is intended as advice to the best of our knowledge. The provided data is based on our own measurements, they do not provide any guaranteed properties nor are these delivery specifications. Due to the versatility of materials, applications and taking in consideration the industrial property rights of third parties, Balver Zinn Josef Jost GmbH & Co. KG cannot take any liability.

CLASSIFICATION	
DIN-EN-ISO-9454-1: 2016	1122
IPC-J-STD-004-A: 2004	ROL0
IPC-J-STD-005: 1995 (Powder)	T4
Particle size	[µm] 20-38

PROPERTIES	
Flux code	JEAN-151
Alloy Code	SAC305
Alloy composition	Sn96.5Ag3Cu0.5
Liquidus	[°C] 219
Solidus	[°C] 217
Recommended peak temp.	[°C] 232-260
Acid number	[mg KOH/g] 123
Flux	[% w/w] 11.3
Residues	Colorless
Tackiness Malcom TK1	IPC-TM-650 2.4.44 [gf] @ 0h 35

TEST REPORTS	
IPC/ANSI-J-STD-005	Compliant
Certificate of Compliance	Website
Declaration of Conformity 2011/65/EU (RoHS)	Available
Application Note	EN/DE
Copper Mirror	IPC-TM-650 2.3.32 Pass
Halides	IPC-TM-650 2.3.33 [Silver Chromate] Pass
Halide	IPC-TM-650 2.3.35.1 [Fluoride by Spot] Pass
Copper Corrosion	IPC-TM-650 2.6.15 Pass
SIR	IPC-TM-650 2.6.3.3 Pass
ECM	IPC-TM-650 2.6.14.1 Pass

PACKAGING AND STORAGE	
Packaging jar	PP [g] 500
Packaging cartridge	HDPE [g] 650
Packaging cartridge	HDPE [g] 1300
Packaging Cassette Pro-Flow	[g] 800
Minimum shelf-life in months	<25 °C 12
Minimum shelf-life in months	4-10 °C 12